

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Hou Te Ng et al

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U.S. Serial No: 10/816,576

Group Art Unit: 2813

Filed On: 24 March 2004

Examiner: Thanh T. Nguyen

Title: "METALLIC NANOWIRE INTERCONNECTIONS  
FOR INTEGRATED CIRCUIT FABRICATION"

Assistant Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia. 22313-1450

AMENDMENT AND RESPONSE (FINAL REJECTION)

Dear Sir:

In response to receipt of an Office Action, mailed 06 April 2006, for the patent application identified above, please enter the following amendments.

Pages 2-4 set forth the claims, as amended

Pages 6-8 set forth a Reply To Examiner's Remarks.

In the claims:

All pending claims are set forth here. Cancel claim 15. Amend claim 1 to read as follows.